

FUJITSU
MICROELECTRONICS

2SD832

SILICON NPN
DARLINGTON TRANSISTOR

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Rating	Symbol	Condition	Value	Unit
Storage Temperature Range	T_{stg}		-55 - +150	$^\circ\text{C}$
Junction Temperature	T_J		+150	$^\circ\text{C}$
Collector-Base Voltage	V_{CB0}		600	V
Emitter-Base Voltage	V_{EBO}		7	V
Collector-Emitter Voltage	V_{CEO}		450	V
Collector Current-Continuous	I_C		50	A
Base Current	I_B		3	A
Collector Power Dissipation	P_C	$T_A = 25^\circ\text{C}$	400	W



ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Symbol	Test Condition	Limit			Unit
		Min	Typ	Max	
I_{CBO}	$V_{CB} = 600\text{V}$ $I_E = 0$	—	—	1.0	mA
I_{EBO}	$V_{EB} = 6\text{V}$ $I_C = 0$	—	—	200	mA
V_{CB0}	$I_C = 1\text{mA}$ $I_E = 0$	600	—	—	V
V_{EBO}	$I_E = 200\text{mA}$ $I_C = 0$	6	—	—	V
$V_{CEO(SUS)}$	$I_C = 0.5\text{A}$ $R_{BE} = \infty$	450	—	—	V
h_{FE}	$V_{CE} = 5\text{V}$ $I_C = 30\text{A}/50\text{A}^*$	-/150	900/300	-/1200	—
$V_{CE(sat)}$	$I_C = 50\text{A}$ $I_B = 1\text{A}^*$	—	1.4	2.0	V
$V_{BE(sat)}$		—	2.0	2.5	V
t_{on}	$V_{CC} = 300\text{V}$ $I_C = 50\text{A}$ $I_{B1} = -I_{B2} = 1\text{A}$	—	1	—	μs
t_{stg}		—	8	—	μs
t_f		—	6	—	μs
f_T	$V_{CE} = 10$ $I_E = 5$	—	8	—	MHz
C_{ob}	$V_{CB} = 50\text{V}$ $I_E = 0$ $f = 1\text{MHz}$	—	500	—	pF

* Pulsed; $P_w = 300\mu\text{s}$, $D_u = 2\%$

PACKAGE TYPE: MD-18. See page 5-23 for dimensions.

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TABLE 1 SATURATION VOLTAGE
 $V_{CE(sat)}$, $V_{BE(sat)}$ — I_C

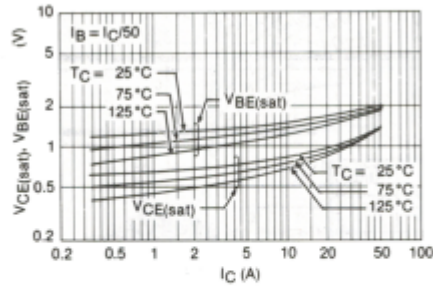
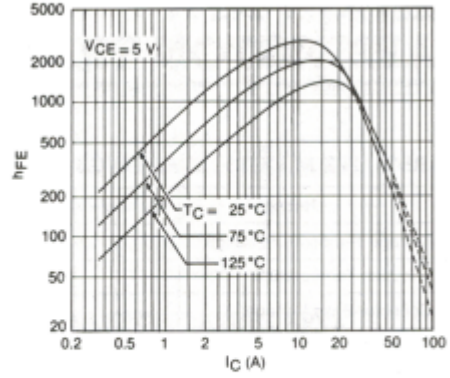


TABLE 2 DC CURRENT GAIN — I_C



TABLES 3 & 4 SWITCHING TIME t_{on} , t_{stg} , t_f — I_C

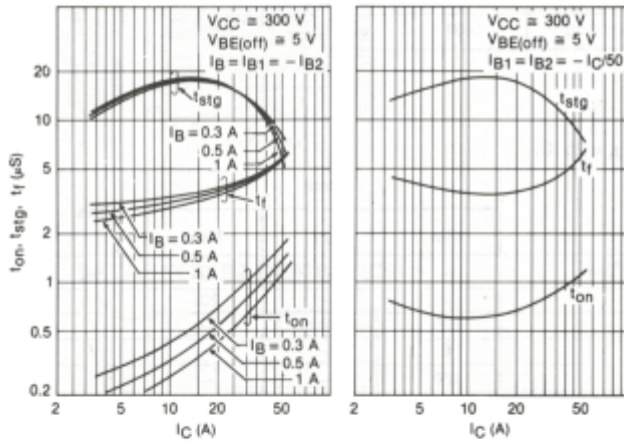


TABLE 6 FORWARD BIAS
 SAFE OPERATING AREA

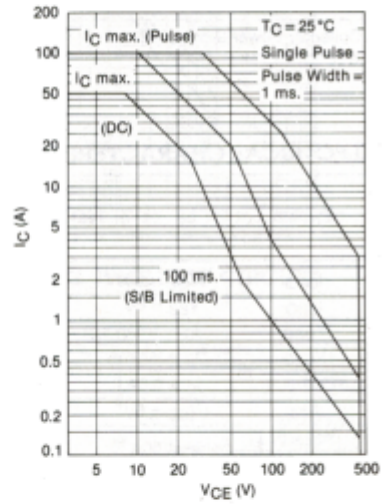
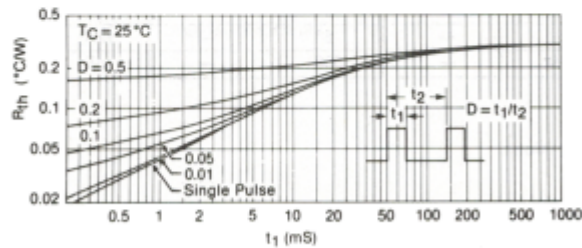


TABLE 5 THERMAL RESPONSE



TRANSISTOR PACKAGING INFORMATION

